

# Introduction to PCB design

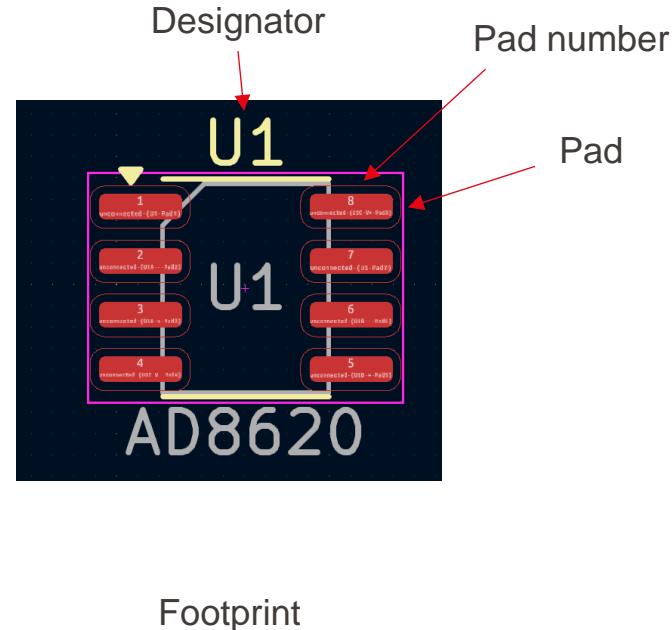
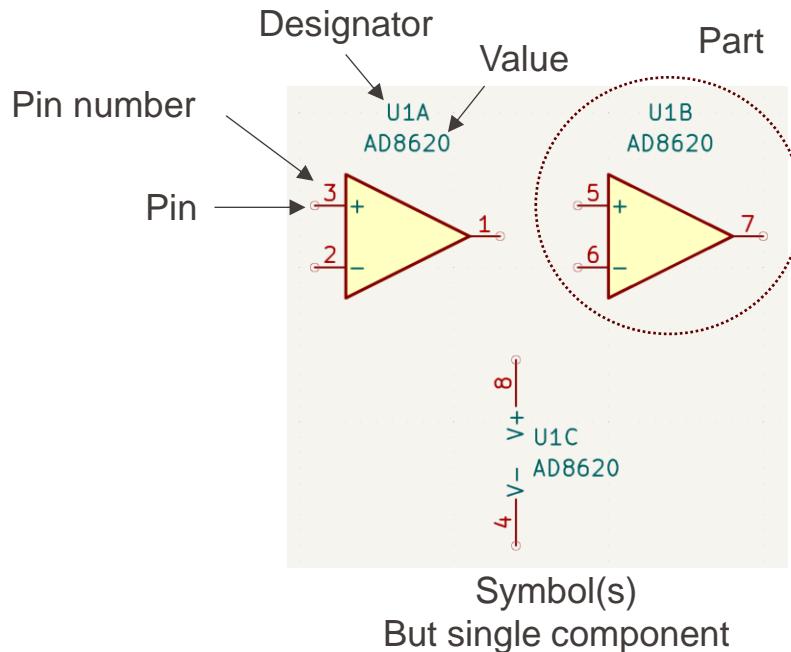
Claude Dahan  
21<sup>st</sup> February 2025

- Electronic Design Automation (EDA), or ECAD
- Many choices with many capabilities:
  - Commonly used free software: KiCAD

Of importance to us:

- Schematic and Layout design capabilities
- Checks:
  - Electrical Rules Check (ERC): Does the schematic make sense?
  - Design Rules Check (DRC): Can the PCB be fabricated?
  - Layout Vs Schematic check (LVS): Does the layout match the schematic?  
(sometimes part of the DRC)

# Symbols & Footprints

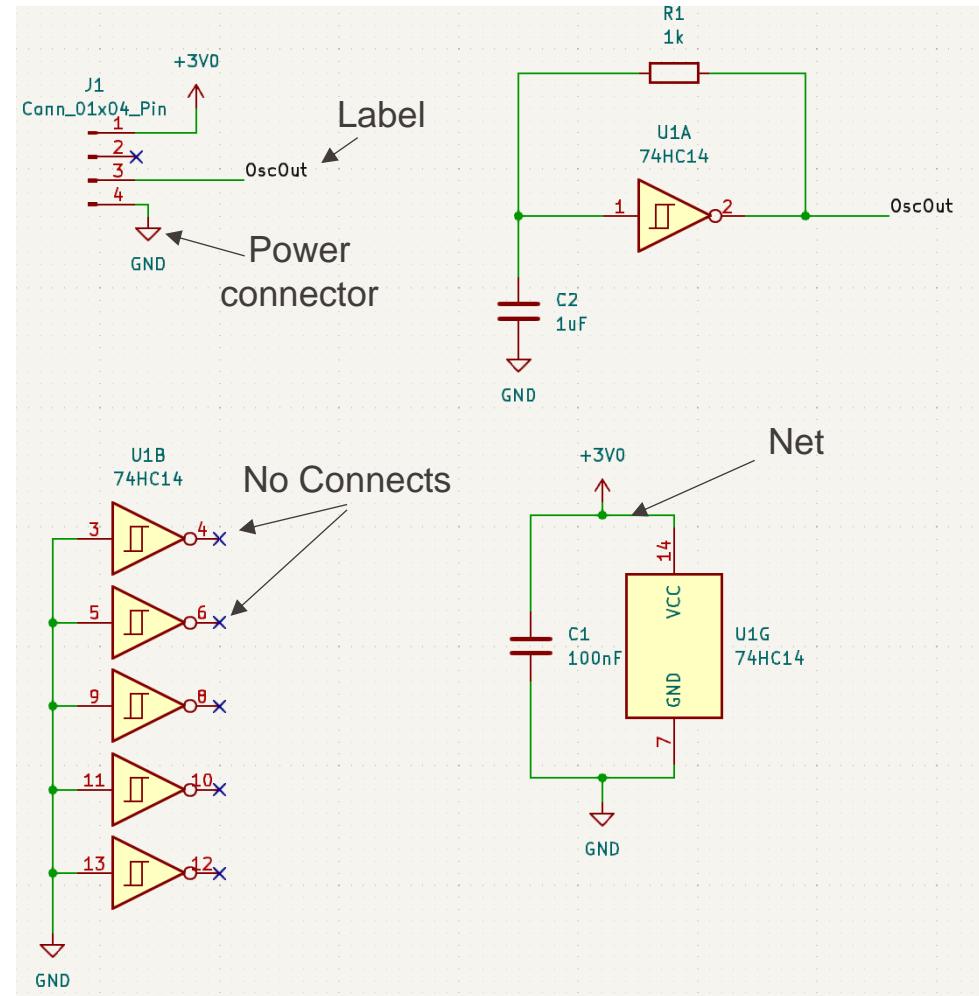


**Pin and pad numbers should match with the component used  
(refer to datasheet)**

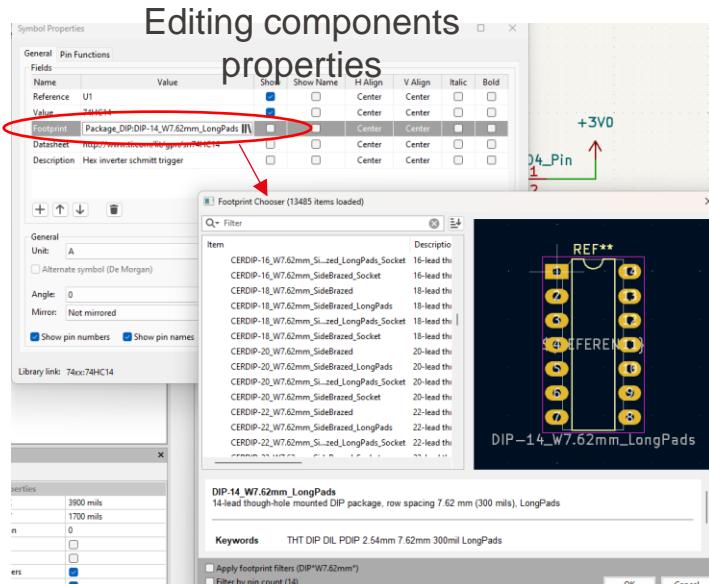
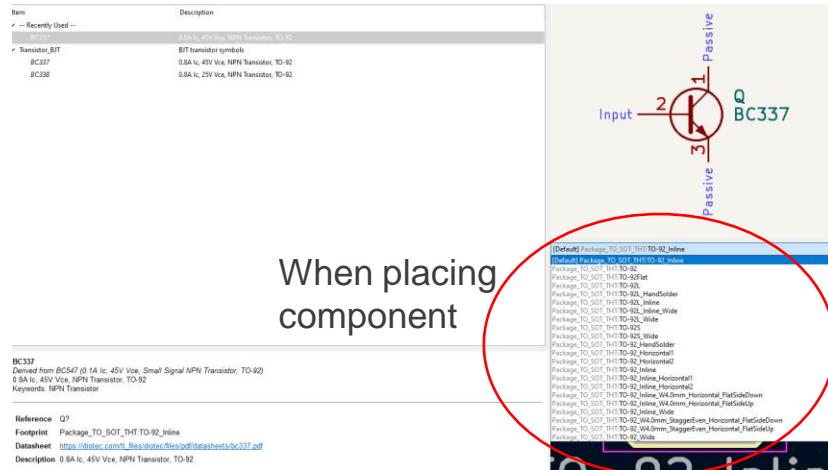
# Schematic example: Basic clock

## Tips & tricks:

- Use net labels to link nets without wires  
(Possibility to have “global labels” to link between sheets)
- Use “No Connect” crosses when pins are unused
- Add decoupling capacitors to ICs
- Place unused parts on the schematic, tie inputs BUT NOT OUTPUTS (obviously)



- Make sure all footprints are already set in schematic
  - If footprint and/or symbol of your component does not exist, create it according to datasheet



# Custom symbols and footprints

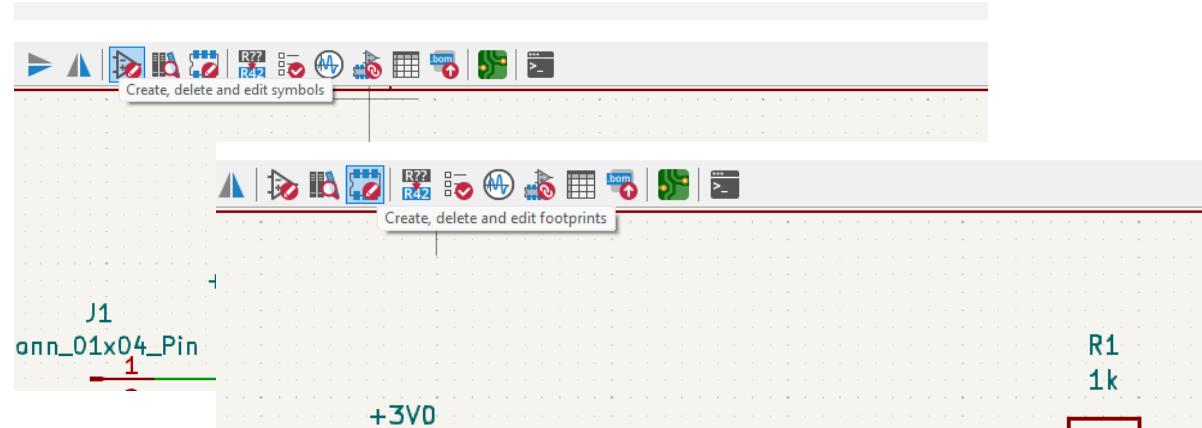
Default library should suffice in most cases, so only briefly shown during demo

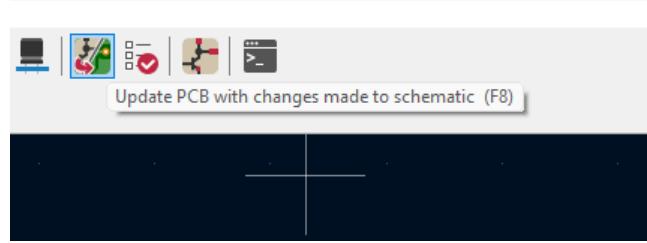
Steps quite self explanatory:

In create symbol window: File→New library  
Select library  
File→New component  
Add pins, set designator, ...

Many resources online if need be, or ask us 😊

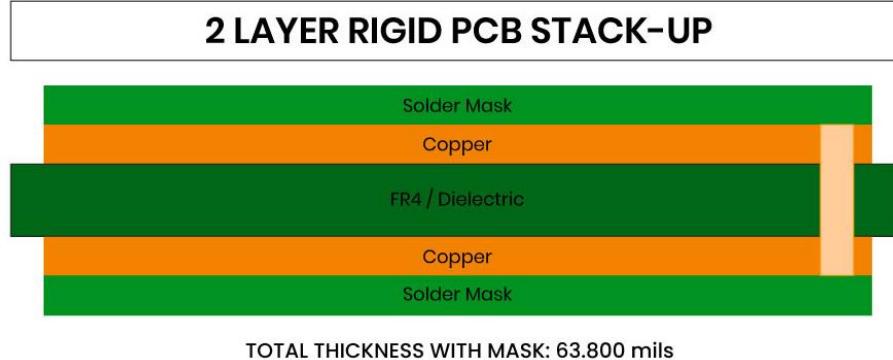
Take care to match pins and pads number order!





- Lists all the components/nets/... not matching between PCB and schematic
- All validated differences will be corrected on the PCB's side, adding components and connections alongside
- Note: Importing from schematic only checks that the component exists. If the footprint was changed in a library, you need to “update footprints from libraries”

## 2 LAYER RIGID PCB STACK-UP



## LAYER DEFINITION

Mask

Layer 1

& silkscreens  
(unavailable at ACI)

Layer 2

Mask



F. : Front side (more often called TOP)

B. : Back side (more often called BOTTOM)

Cu: Where there is copper (tracks, pads, ...)

Paste: For solder paste, usually equal to "mask"

Silkscreen: For annotations

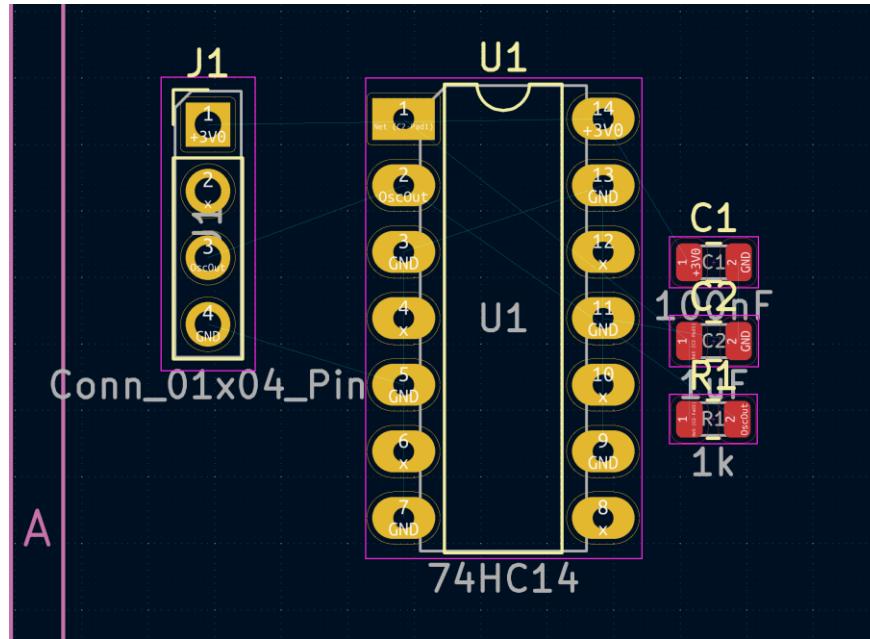
Mask: Where no solder mask should be placed

Edge cuts: Shape of the board

Fab: Fabrication schematic/annotations

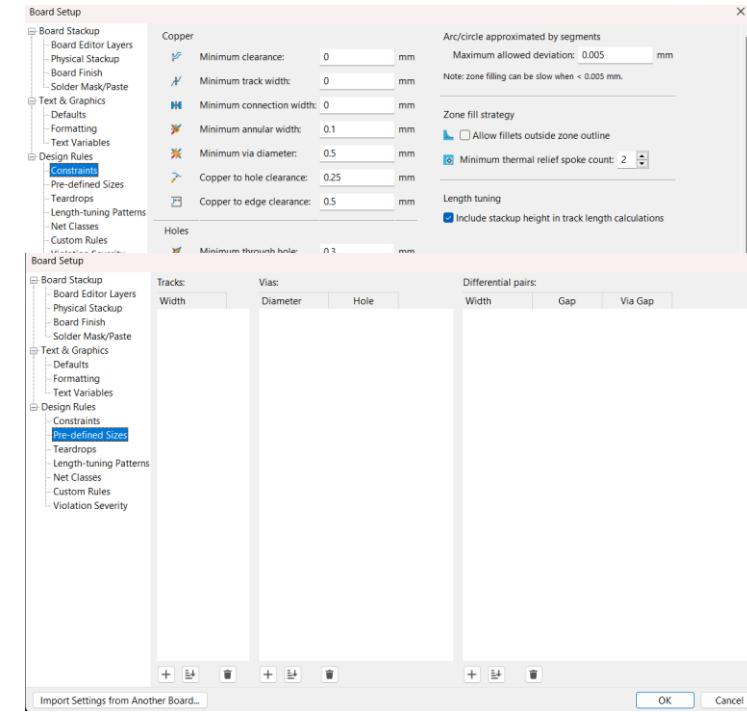
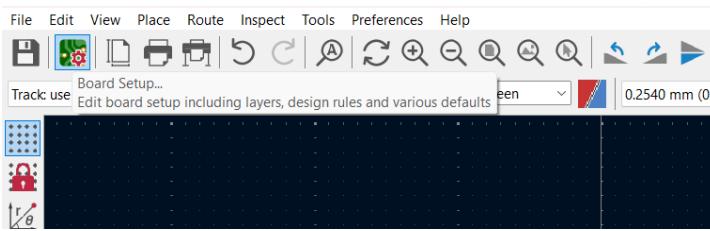
...

- Once everything imported from schematics, it's time to plan the routing
- Keep the final application in mind:
  - Decoupling caps close to ICs' power pins
  - Mechanical constraints (location of connectors, holes, ...)
- Ratsnest: small lines showing the connections remaining



# Set board rules

- Prepare rules corresponding to fabrication constraints
- **Good to do early on**



# Board rules

ACI gives set of rules.

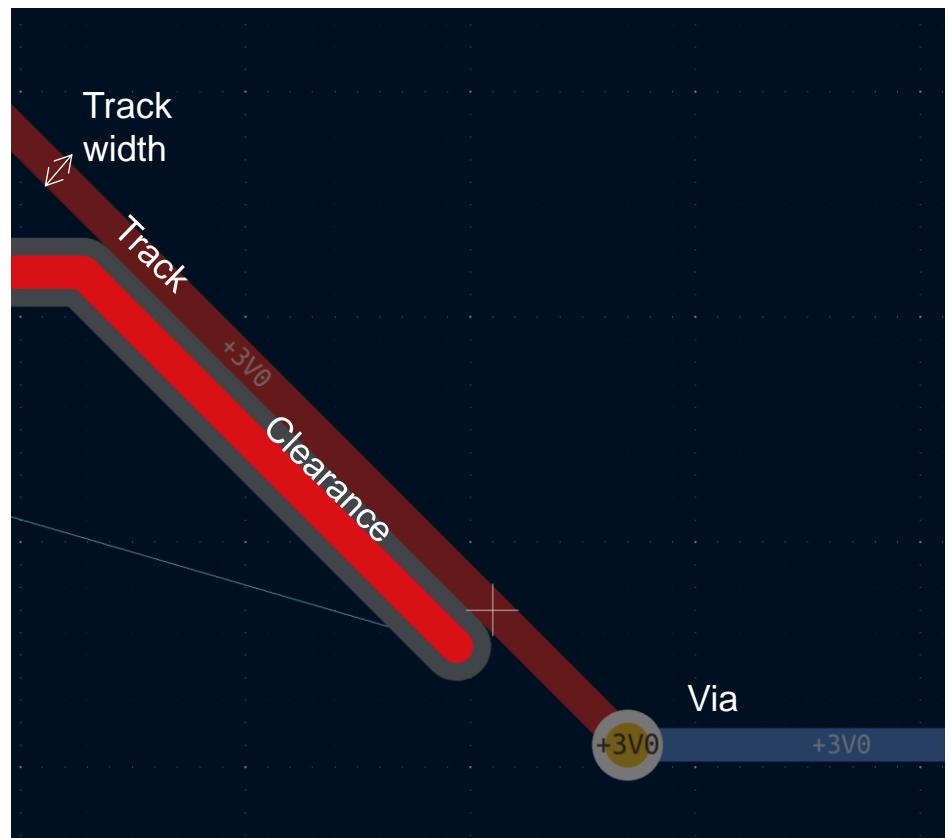
(our PCB is made of FR4 0.8mm, 12um Cu)

Standard Dimensions (in mm)		
Description	PCB size max.	Panel size max.
Small	148 x 180	170 x 250
Medium	228 x 230	250 x 300
Large	228 x 310	250 x 380

Hole Diameter (in mm)		
Material Thickness	Min. Hole Diameter	Max. Hole Diameter
0.8	0.3	6.2

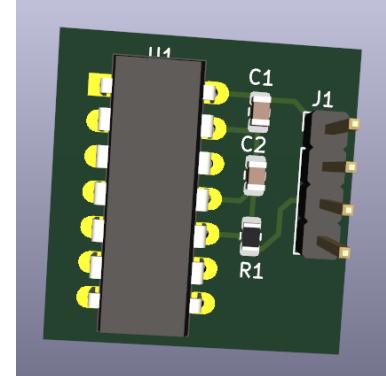
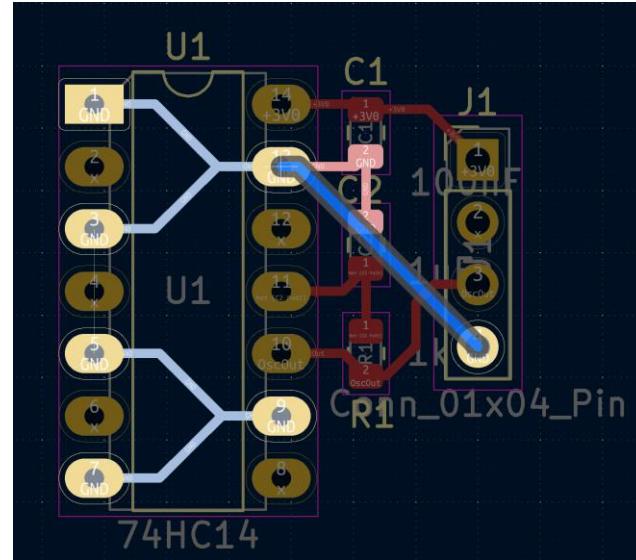
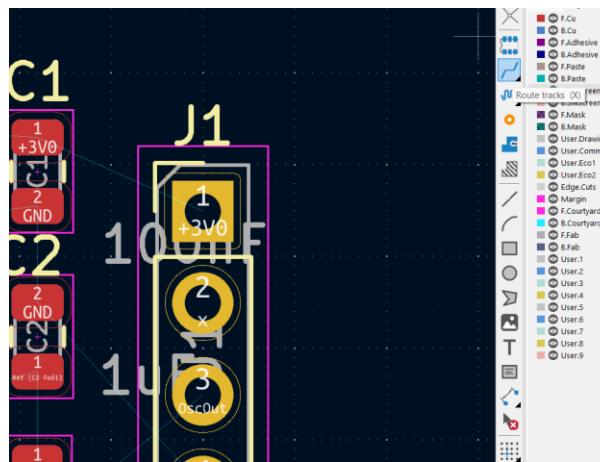
## Available drills:

- From 0.25 up to 3.25 mm, by steps of 0.05
- From 3.30 up to 6.2 mm, by steps of 0.1
- Drill diameters above 6.2 mm must be placed in the Outline file, GERBER RS-274X format



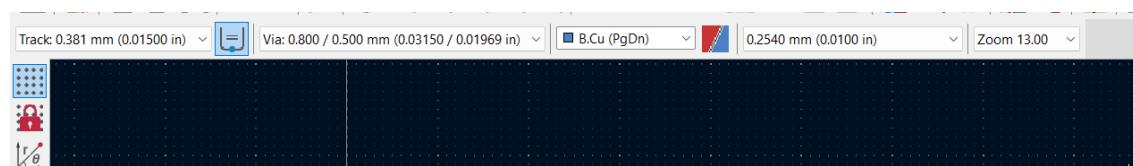
In brief, for our application:

- Width and clearance of minimum 250 $\mu$ m (10mil)
- Adapt width to current if high current application
- Via of 800 $\mu$ m, with hole of 500 $\mu$ m



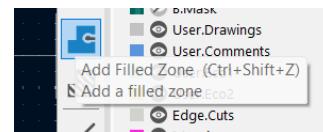
Use shortcuts:

Route (X), place vias (V), flip component to other layer (F), ...

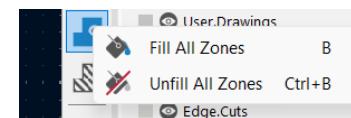


# Ground plane

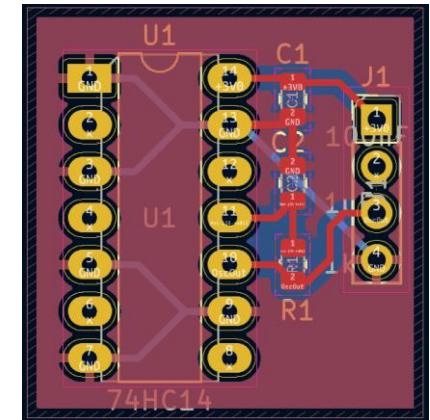
- Once the routing is finished, it is good practice to add a ground plane, to improve the shielding on the PCB, and reduce copper waste in fabrication

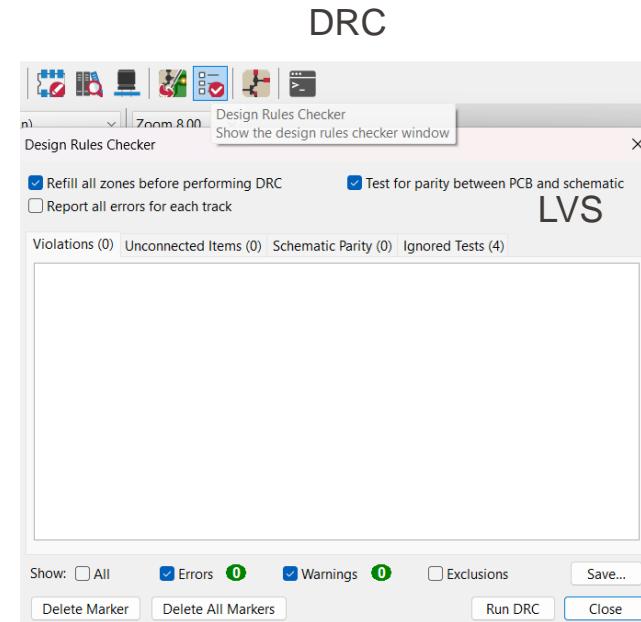
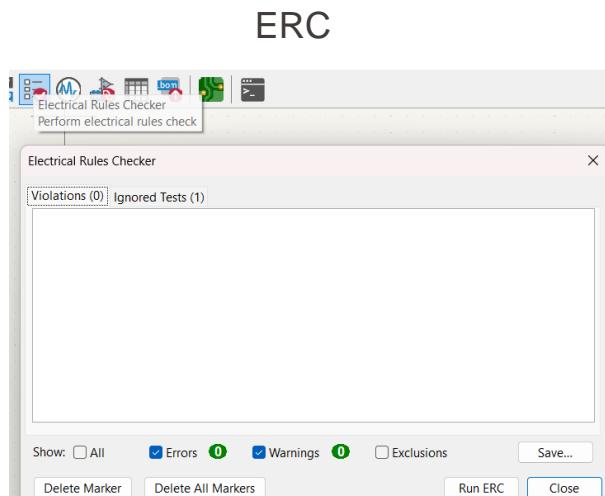


- Select a copper layer →
- Add a zone following the PCB's edges, on TOP & BOTTOM, tied to GND

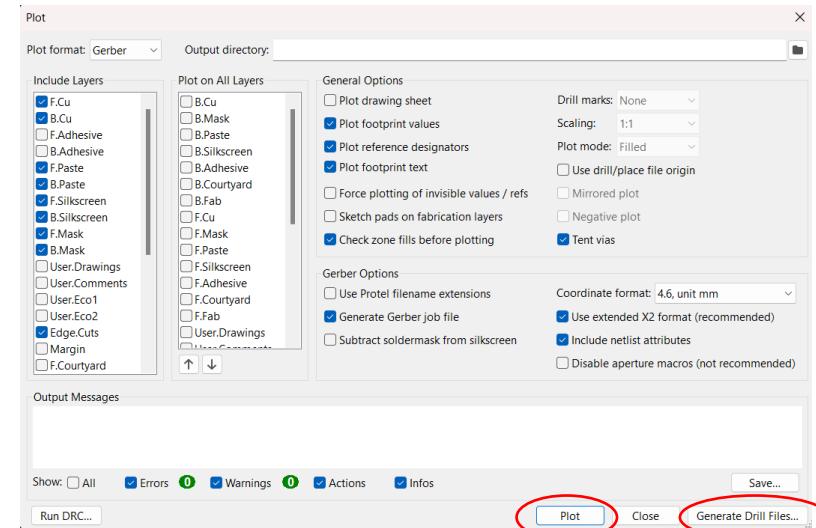
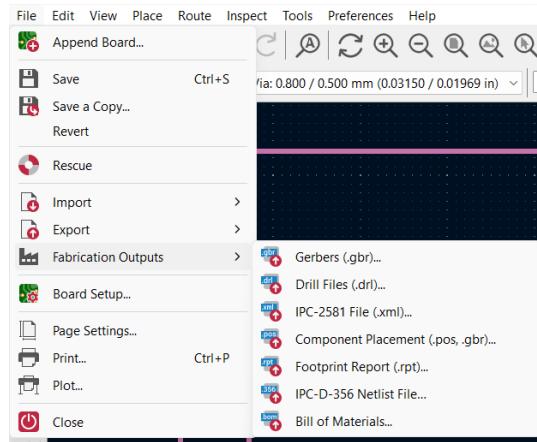


- You can “pour” it, with right click → or by running the DRC





# Gerber files



“Gerber files” are fabrication files containing each layer’s pattern  
To make the PCB, both Gerber and Drill files are needed

“Include layers” → One file per layer, as needed for fabrication

“Plot on all layers” → Useful to export a PDF showing the final PCB and verify by hand

To provide:

**Gerbers of Copper, Paste and Mask layers (no silkscreen needed)**

**Drill Files** (Excellon, other parameters should not matter as defined in the file itself)  
**PDF to scale of PCB layout**